imall

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High Voltage Switching Diode

The BAS21TMR6T1G device houses three high-voltage switching diodes in a SC-74 surface mount package. This device is ideal for low-power surface mount applications where board space is at a premium.

Features

- Reduces Board Space
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	250	Vdc
Forward Current	١ _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	625	mAdc

THERMAL CHARACTERISTICS

		-		
Characteristic	Symbol	Max	Unit	
Total Device Dissipation FR-5 Board (Note 1) T _A = 25°C Derate above 25°C	PD	311 2.5	mW mW/°C	
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	402	°C/W	
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	P _D	347 2.8	mW mW/°C	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	360	°C/W	
Junction and Storage Temperature	T _J , T _{stg}	–55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

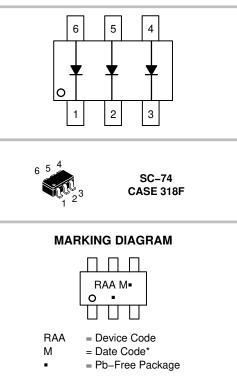
1. FR-4 @ 10 mm², 2 oz copper traces 2. FR-4 @ 25 mm², 2 oz copper traces



ON Semiconductor®

www.onsemi.com

250 V **HIGH VOLTAGE** SWITCHING DIODE



(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
BAS21TMR6T1G	SC–74 (Pb–Free)	3000 / Tape & Reel
NSVBAS21TMR6T1G	SC–74 (Pb–Free)	3000 / Tape & Reel
NSVBAS21TMR6T2G	SC–74 (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

BAS21TMR6

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
Reverse Voltage Leakage Current ($V_R = 200 \text{ Vdc}$) ($V_R = 200 \text{ Vdc}$, $T_J = 150^{\circ}\text{C}$)	I _R		0.1 100	μAdc	
Reverse Breakdown Voltage (I _{BR} = 100 µAdc)	V _(BR)	250	-	Vdc	
Forward Voltage (I _F = 100 mAdc) (I _F = 200 mAdc)	V _F		1.0 1.25	Vdc	
Diode Capacitance ($V_R = 0, f = 1.0 \text{ MHz}$)	CD	-	5.0	pF	
Reverse Recovery Time (I _F = I _R = 30 mAdc, I _{R(REC)} = 3.0 mAdc, R _L = 100)	t _{rr}	-	50	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

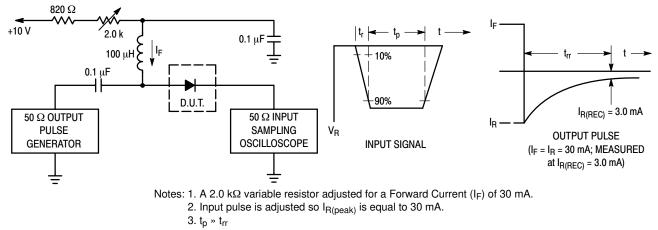
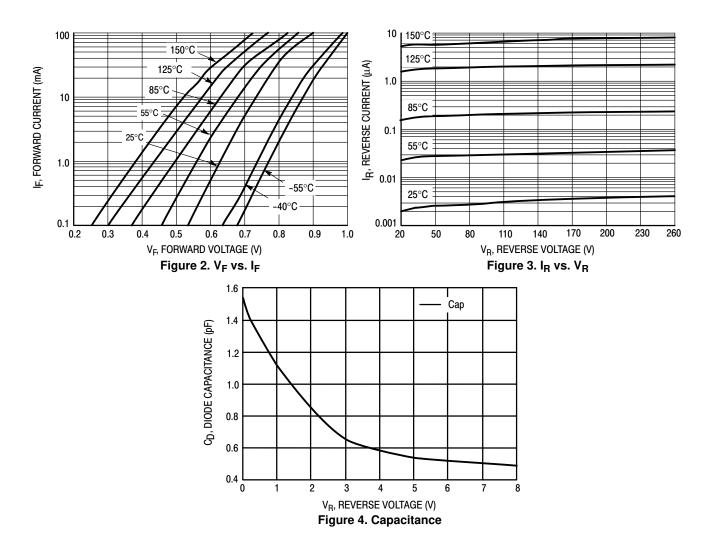


Figure 1. Recovery Time Equivalent Test Circuit

BAS21TMR6

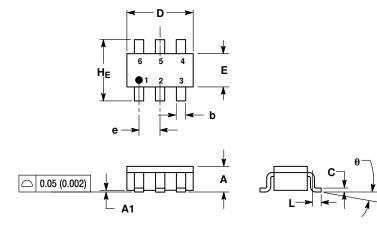
TYPICAL CHARACTERISTICS



BAS21TMR6

PACKAGE DIMENSIONS

SC-74 CASE 318F-05 **ISSUE N**

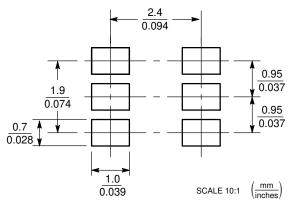


NOTES:

- DIRENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 318F-01, -02, -03 OBSOLETE. NEW STANDARD 318F-04.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.90	1.00	1.10	0.035	0.039	0.043	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.25	0.37	0.50	0.010	0.015	0.020	
С	0.10	0.18	0.26	0.004	0.007	0.010	
D	2.90	3.00	3.10	0.114	0.118	0.122	
E	1.30	1.50	1.70	0.051	0.059	0.067	
е	0.85	0.95	1.05	0.034	0.037	0.041	
L	0.20	0.40	0.60	0.008	0.016	0.024	
HE	2.50	2.75	3.00	0.099	0.108	0.118	
θ	0°	-	10°	0°	-	10°	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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